#### 504472995 07/25/2017

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT4519697

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
YOSHIYUKI KUROKAWA	03/25/2015
HIDEKI UOCHI	03/26/2015

### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15609609

### CORRESPONDENCE DATA

Fax Number: (877)769-7945

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (202) 783-5070 Email: APSI@fr.com Correspondent Name: JOHN F. HAYDEN

Address Line 1: FISH & RICHARDSON P.C.

Address Line 2: P.O.BOX 1022

Address Line 4: MINNEAPOLIS, MINNESOTA 55440-1022

ATTORNEY DOCKET NUMBER:	12732-1478002
NAME OF SUBMITTER:	JANELLE A. JACKSON
SIGNATURE:	/Janelle A. Jackson/
DATE SIGNED:	07/25/2017

**Total Attachments: 1** 

504472995

source=12732-1478002 Assignment#page1.tif

**PATENT** REEL: 043094 FRAME: 0114

# **ASSIGNMENT**

For valuable consideration, We, Yoshiyuki KUROKAWA of Sagamihara, Kanagawa, Japan and Hideki UOCHI of Atsugi, Kanagawa, Japan hereby assign to Semiconductor Energy Laboratory Co., Ltd., a Japanese corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title ar
interest throughout the world in the inventions and improvements which are subject of an application for
United States Patent signed by us this day, entitled SEMICODNCUTOR DEVICE, METHOD FO
DRIVING SEMICODNCUTOR DEVICE, AND METHOD FOR DRIVING ELECTRONIC DEVICE
filed April 6, 2015, and assigned U.S. Serial Number 14/679,172, and w
authorize and request the attorneys appointed in said application to hereafter complete this assignment b
inserting above the filing date and serial number of said application when known; this assignment includin
said application, any and all United States and foreign patents, utility models, and design registration
granted for any of said inventions or improvements, and the right to claim priority based on the filing date of
said application under the International Convention for the Protection of Industrial Property, the Pater
Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and w
authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models
design registrations and like rights of exclusion and for inventors' certificates for said inventions an-
improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns
without further compensation to perform such lawful acts and to sign such further applications, assignments
Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate
fully this assignment.
Signature <u>Yoshiyuki Kurokawa</u> Name: Yoshiyuki KUROKAWA
Name: Yoshiyuki KUROKAWA
Date: 03/25/2015
Signature <u>Hideki Vochi</u>
Name: Hideki UOCHI  Date: 03/26/2015
Date: $\frac{03/26/2015}{}$

Date:

RECORDED: 07/25/2017

**PATENT** REEL: 043094 FRAME: 0115